-	ON TOR PATENT APPLICATION	(WITH POWER (TITOKNEY)		
As an inventor named below or on	any a sed continuation page, I hereby declare	that:		
My residence, post office address as	nd citizenship are as stated next to my name.			
below) of the subject matter which is cl	and sole inventor (if only one name is listed be aimed and for which a patent is sought on the i	low) or an original, first and joint inventor (if	plural names are	e listed
DEVICES, PACKAGES INCLUDING	SAME, AND METHODS OF FABRICATION	, the specification of which (check one):	OR SEMICON	DUCTO
B is attached hereto.		,		
	nited States application serial noa	nd was smended on		
us filed on as PC	T international application noand	was amended under PCT Article 10 on		
		-	···········•	
I hereby state that I have reviewed a referred to above.	nd understand the contents of the above-identifi	ed specification, including the claims, as amen	ded by any amer	ndment
I acknowledge the duty to disclose to matter claimed in this application, as "m	the U.S. Patent and Trademark Office all info ateriality" is defined in Title 37, Code of Fede	rmation known to me to be material to the paterial Regulations § 1.56.	entability of the s	subject
I hereby claim foreign priority benefit	s under Title 35, United States Code, § 119 (a)	e(d) or 8 365(b) of any foreign and liquities ().		
centificate of § 303(a) of any PC1 intern	BillOnal application(s) designating at least one c	nunity other then the United States of America	15.4 . 4 . 4	
arraction continuation hase and trave areo	identified below and on any attached continual	on page any foreign application for natent or	inventanta	on any
any FC1 international application(s) desi	guating at least one country other than the Unit	ed States of America having a filing date befo	re that of the	0210 01
application(s) on which priority is claime	.			
Prior foreign/PCT application(s):				
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(number)	(country)			
((county)	(day/month/year filed)	Yes	No
. (number)	(country)	(day/month/year filed)	Yes -	No
I hereby claim the henefit under Title 3	5, United States Code, § 120 of any United St			
designating the United States of America	listed below and on any attached continuation	stes application(s) or § 303(c) of PCT internal	ional application	1(2)
application is not disclosed in any such pr	rior application in the manner provided by the	rage and, misorar as the subject matter of each	of the claims of	f this
tine duty to disclose to the U.S. Faterit and	I levemark Unice all information known to n	e to be material to natentability as defined :	Tit. 22	
Regulations § 1.56 which became availab	le between the filing date of such prior applica	ion and the national or PCT international filin	nue 37, Code o	it Federa
	-	The state of the s	g date of dis ap	pilcation
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	(g cars)	(status - pending, patented or	ibandoned)	
(application serial no.)	(filing date)	(status - pending, patented or		
I hereby claim the henefit under Title 3	5, United States Code, § 119(e) of any United		ivanidoned)	
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(provisional application no.)	(filing date)		_	
	ed Practitioners to prosecute this application as	d to transact all business in the Batana and Tra	,	
connected therewith:	by the process and approaches an	o to transact an Ansuness III file Lafelif and IL	ademark Office	
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I hereby declare that all statements made	herein of my own knowledge are true and the	at all statements made on information and hel	ief ere believed (to be
tract and intaict mat mese statements were	midde with the knowledge that willful false et	tements and the like so made are munichable t	4	
or both, under Section 1001 of Title 18 of t patent issued thereon.	he United States Code and that such willful fa	se statements may jeopardize the validity of t	he application or	r any
harane toomen metechii				-
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All All Million Deliver	, Doing and 03/00			

Invention title: PLASTIC LEAD FRAMES FOR SEMICONDUCTOR DEVICES, PACKAGES INCLUDING SAME, AND METHODS OF FABRICATION

Inventor name(s) appearing on first declaration page: Tongbi Jiang

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